



Modeling of SiC single crystal growth in PVT reactor

T. Wejrzanowski, J. Dagiel, M. Grybczuk, J. Niescior, K.J.
Kurzydowski

Faculty of Materials Science and Engineering
Warsaw University of Technology
Woloska 141 str., 02-507 Warsaw, Poland
e-mail: twejrzanowski@inmat.pw.edu.pl

E. Tymicki

Institute of Electronic Materials Technology
Wolczynska 133 str., 01-919 Warszawa, Poland



Outline of the presentation

1. The purpose of the studies
2. The scope of the studies
3. The methods
 - ▶ Model of the reactor geometry
 - ▶ Finite Volume Method
 - ▶ Implementation of the reactions
 - ▶ Dislocation evolution model
4. Results and experimental verification
5. Summary



The purpose of the studies

Optimization of SiC monocrystal growth process by computer modelling



Silicon carbide polycrystal (left) and monocrystalline SiC wafers (right). Source: ITME

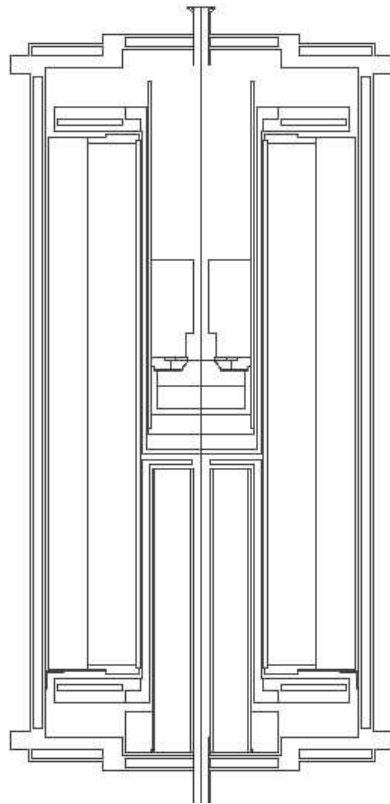


The scope of the studies

- ▶ Optimization of the thermal conditions by modifications of the reactor geometry
 - ▶ Different solutions related with geometry of insulation
- ▶ Optimization of the process conditions
 - ▶ Temperature and temperature gradient
 - ▶ Pressure



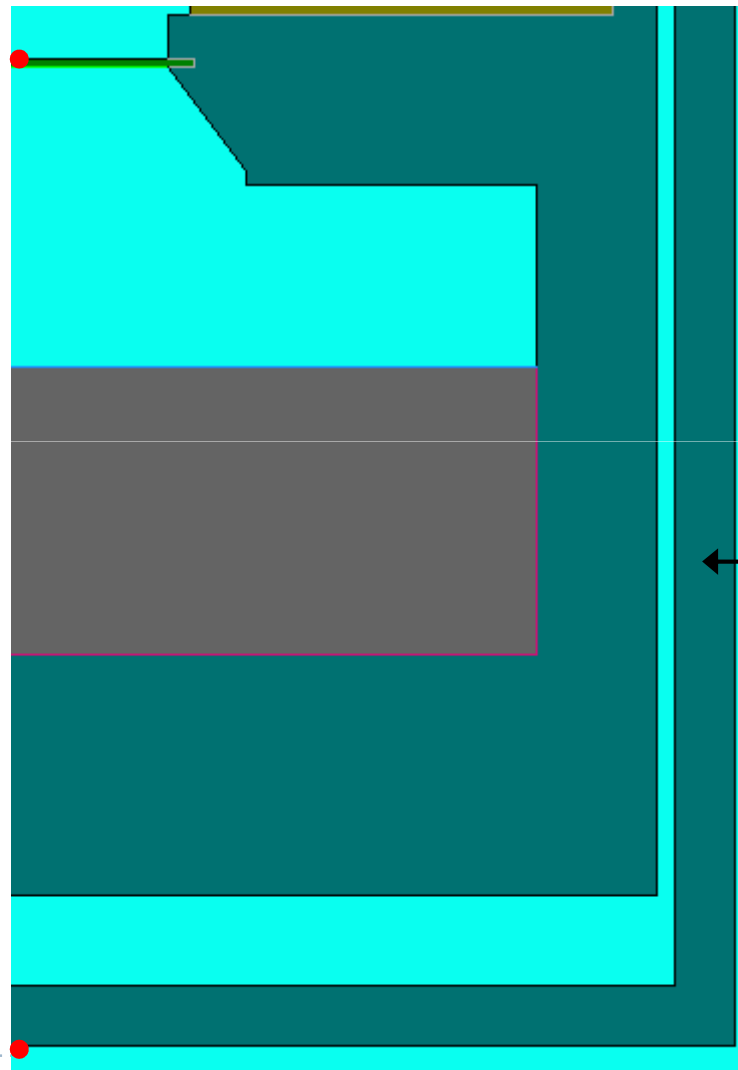
Virtual Reactor and reactor model



- ▶ **Geometry**
 - ▶ Two-dimensional
 - ▶ Axisymmetric
- ▶ **Boundary conditions**
 - ▶ Temperatures
 - ▶ Chemical activity
- ▶ **Heat transfer**
 - ▶ Conductivity
 - ▶ Convection
 - ▶ radiation



Reactor model



- Seed crystal
- Source
- Graphite
- Argon

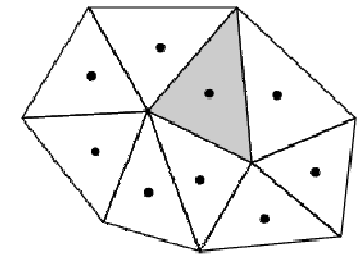
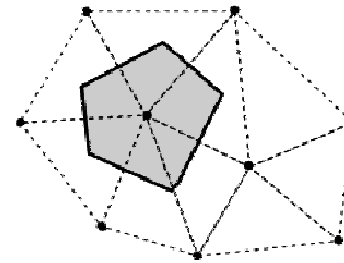
- Temp. measuring point
- Upper resistive heater



Finite Volume Method

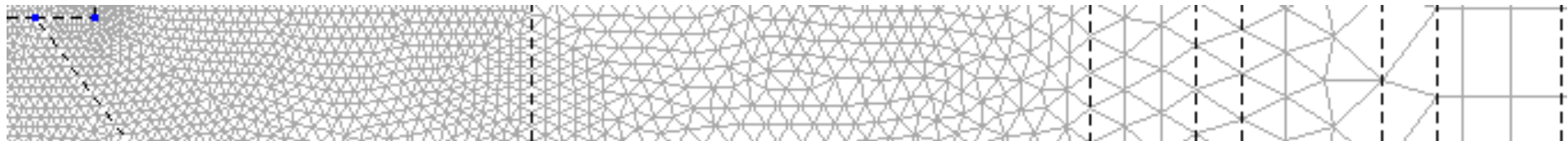
Piecewise constant cell average for each control volume:

$$u_i = \frac{1}{|V_i|} \int_{V_i} u dV$$



Approximation of flux integral by a quadrature rule:

$$\int_{\partial V} f(u) \cdot dA \approx \sum_{f_{jk} \in \partial V} g_{jk}(u_j, u_k)$$

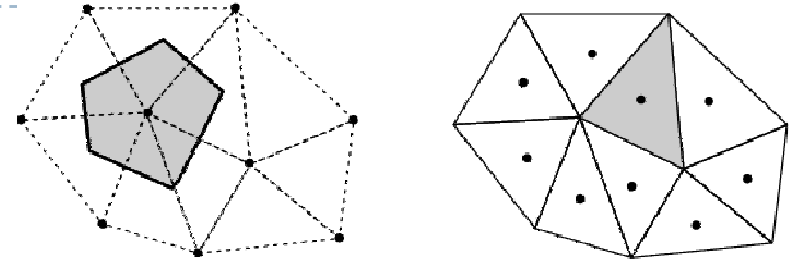


Mesh density decreases with distance from the furnace axis. Less crucial parts, like outermost thermal insulation, are less densely covered what simplifies calculations. (VR

Heat Transfer Model

Heat conduction in solids:

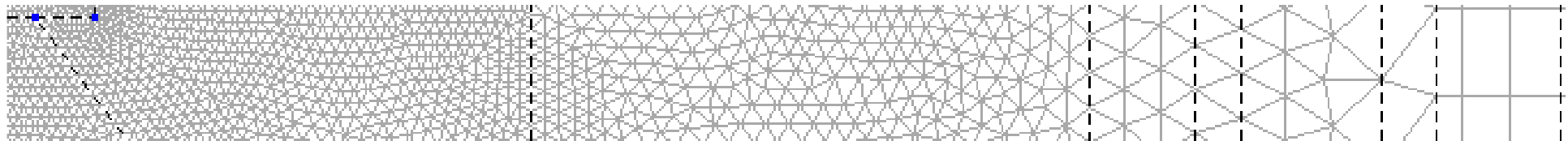
$$-\frac{\partial}{\partial x_i} \left(\lambda_{ik} \frac{\partial T}{\partial x_k} \right) = Q$$



Heat flux at the 'constant wall temperature' boundary:

$$q_w = \lambda \frac{T_w - T_c}{dx}$$

Finite Volume Method has been utilized for heat transfer in the simulation

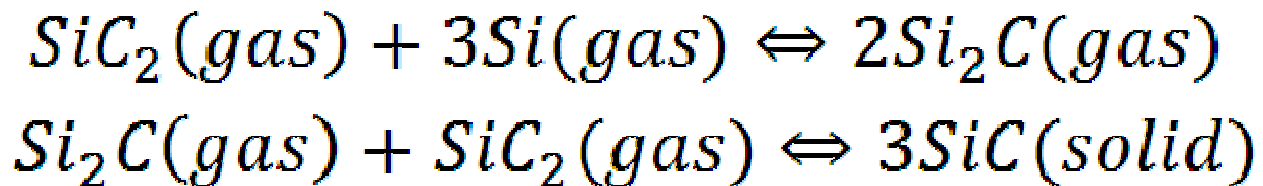


Mesh density decreases with distance from the furnace axis. Less crucial parts, like outermost thermal insulation, are less densely covered what simplifies calculations. (VR

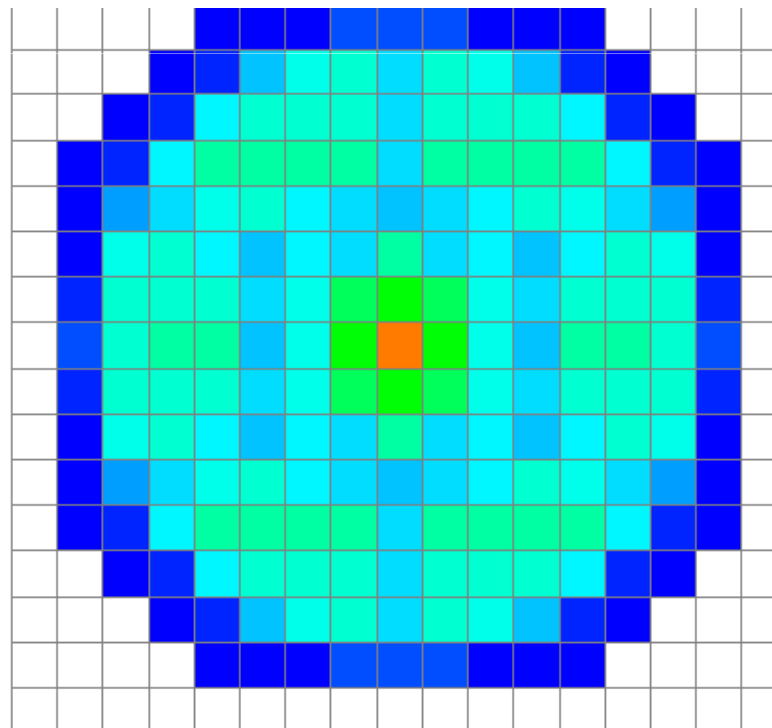
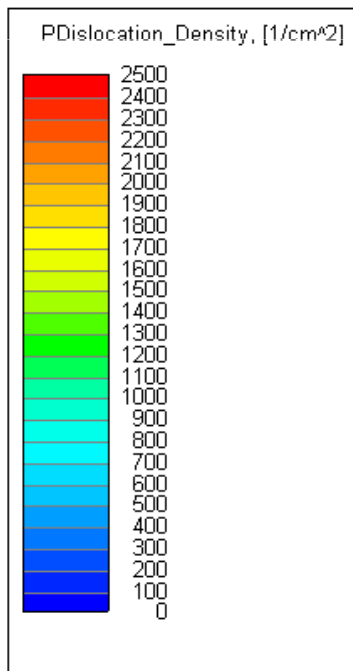
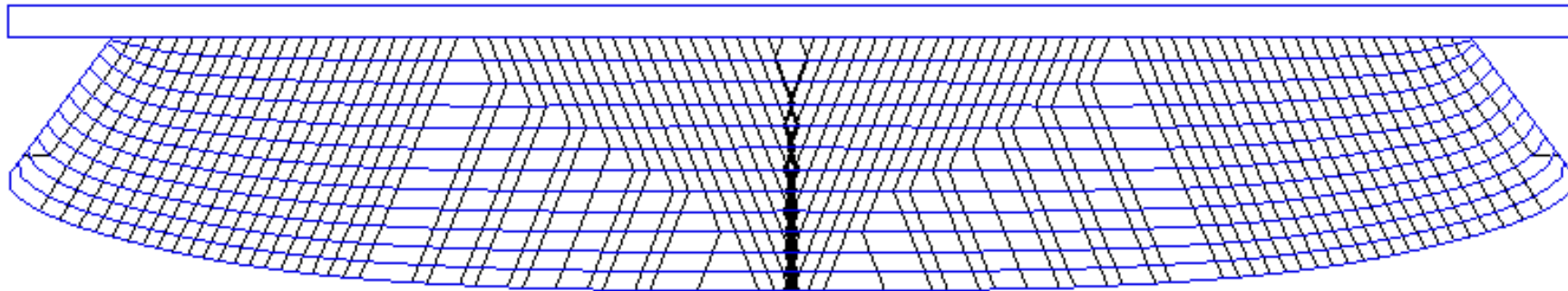


Implementation of the reactions

- ▶ Gas phase consists of Si, Si₂C, SiC₂ and Ar
- ▶ Reactions at crystal surface



Dislocation evolution model

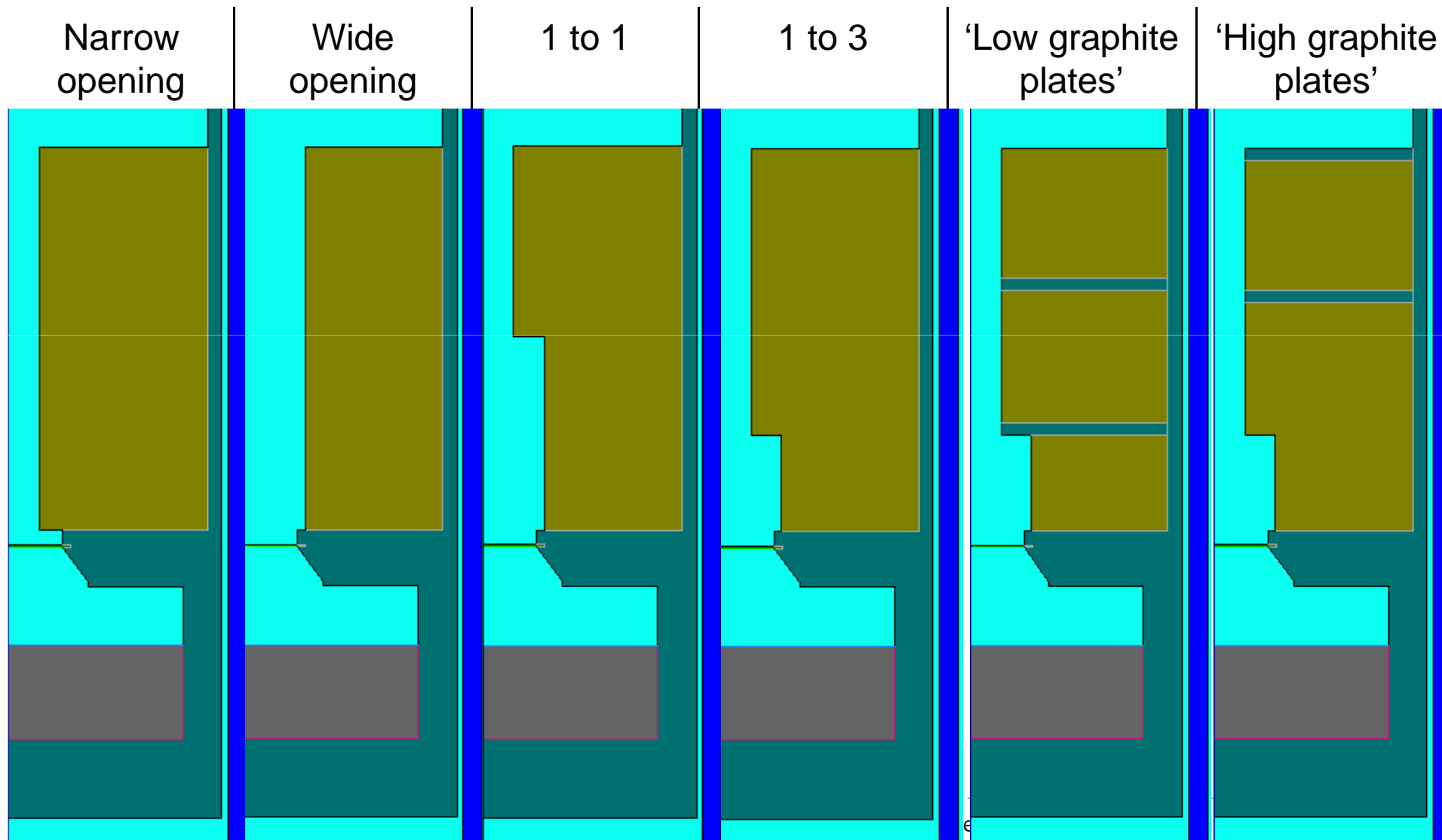


Threading dislocation traces , cut through crystal axis (above)

Threading dislocation density mapping, 7mm from the seed surface (left)
 Output from VirtualReactor

$$E_{seg} = K(\alpha)L_{seg}(\alpha)$$

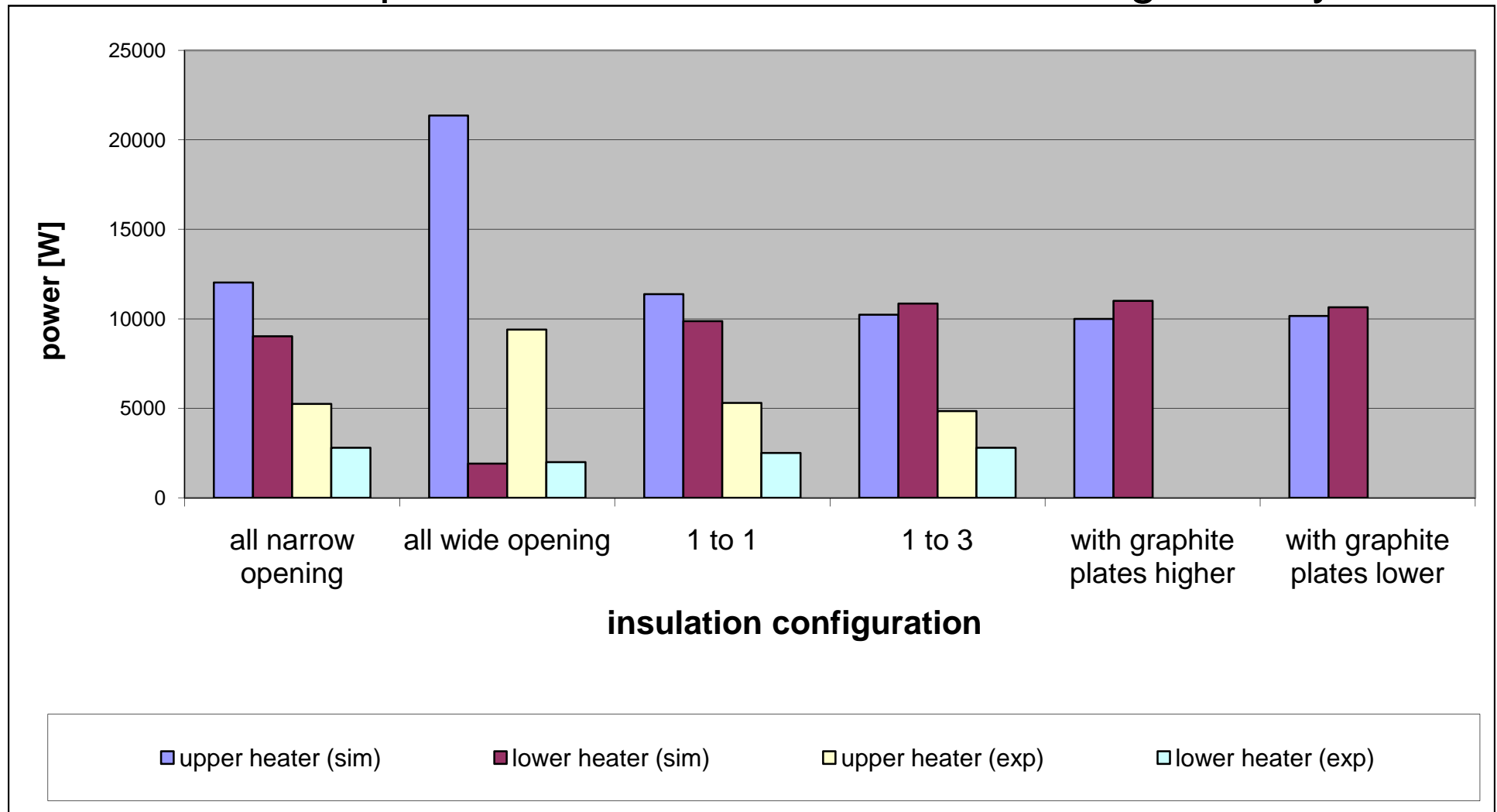
Insulation geometry





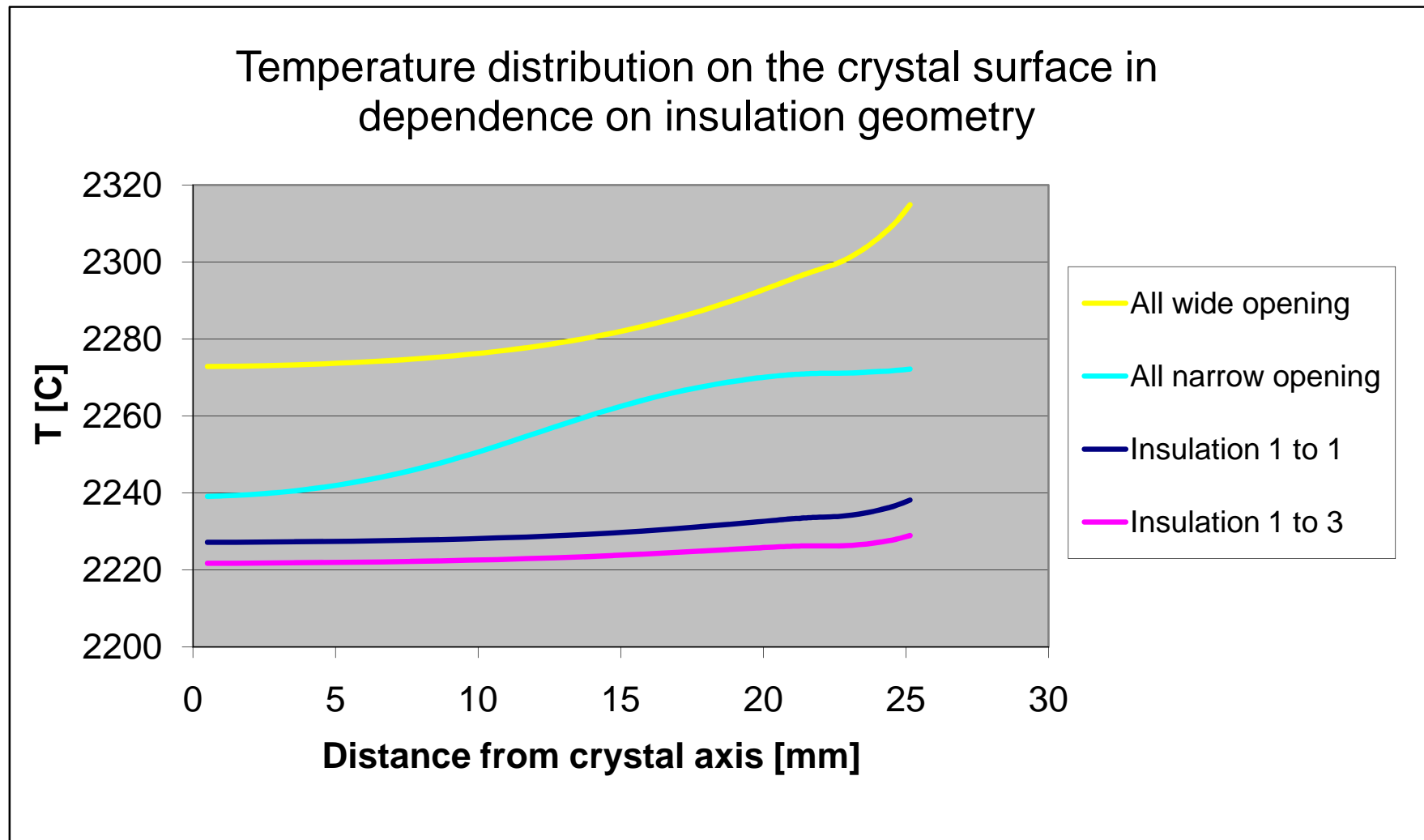
Insulation and heater power

Comparison of simulated and experimentally obtained heater power in accordance to insulation geometry





Insulation and seed temperatures





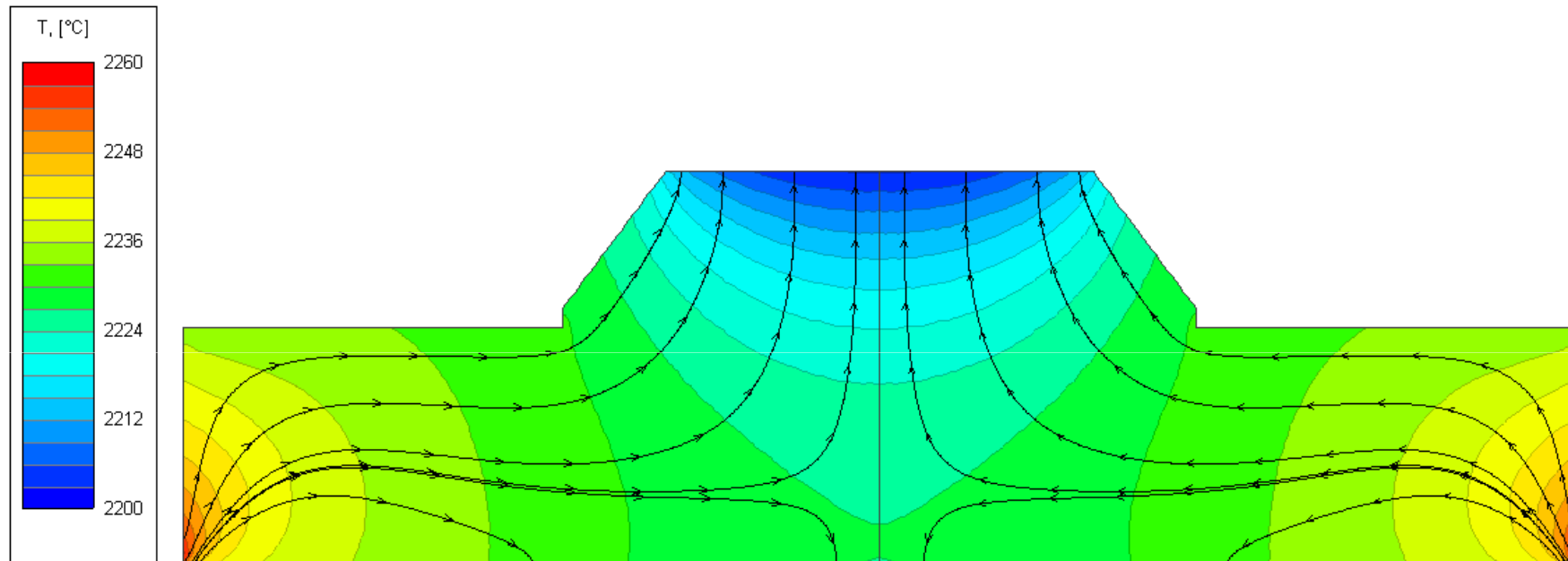
Growth rate

▶ The aim

- ▶ Investigation of crystal growth rate evolution in time
- ▶ Examination of pressure impact on growth rate
- ▶ Examination of temperature and temperature gradient impact on growth rate

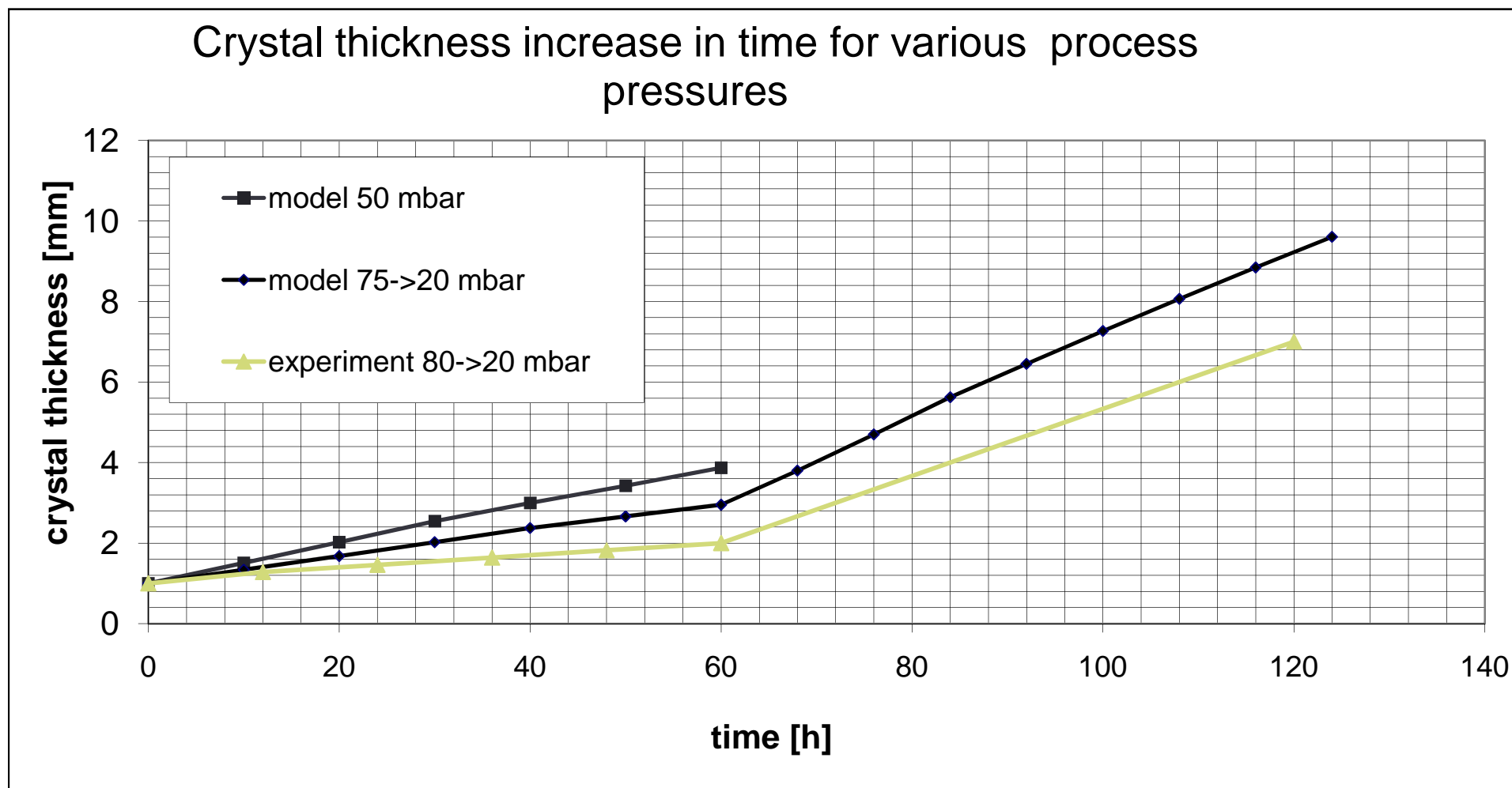


Growth rate



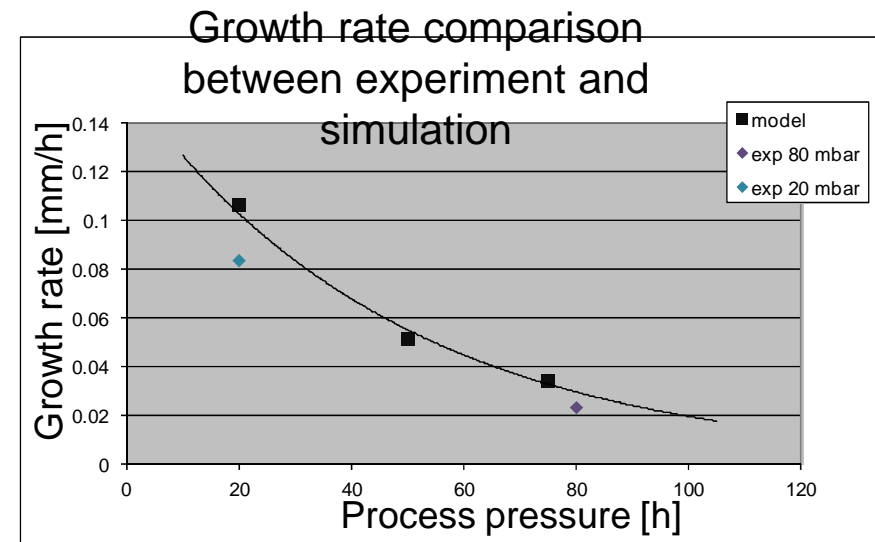
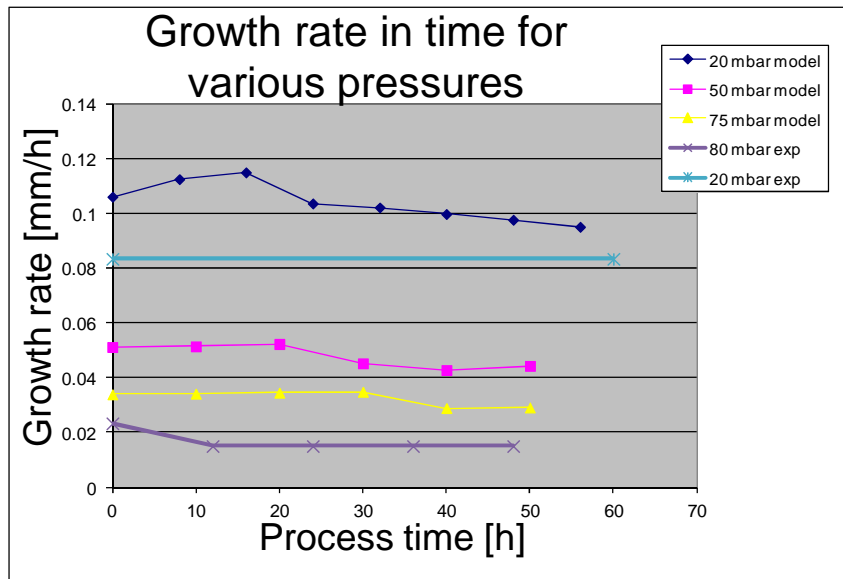


The effect of pressure on crystal growth



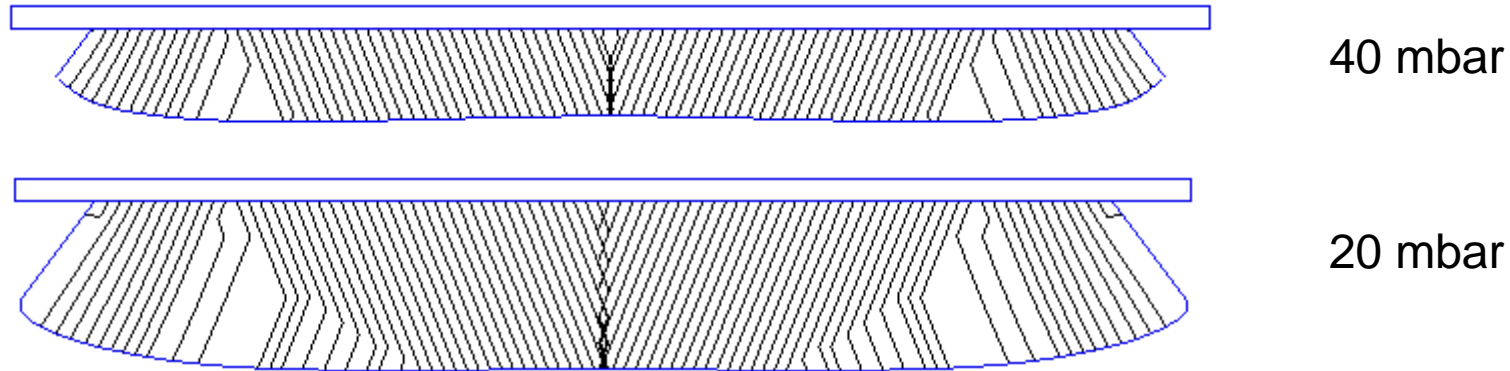


The effect of pressure on growth rate

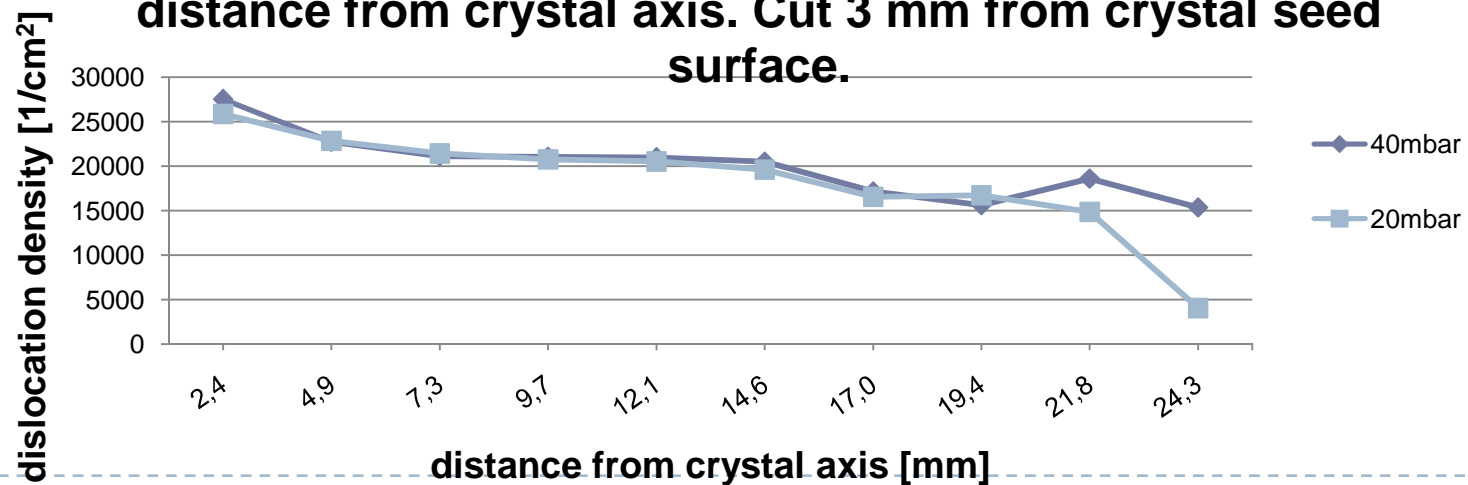




Pressure and dislocations



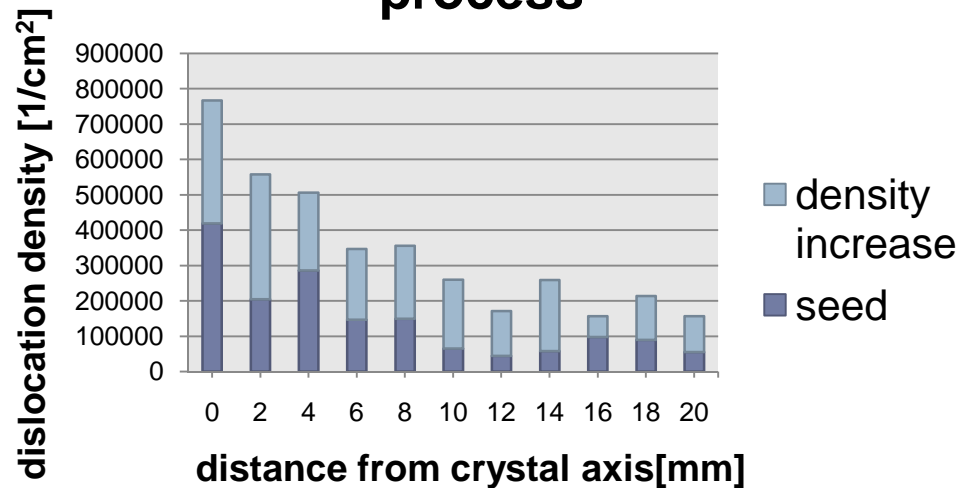
Comparison of dislocation densities as a function of distance from crystal axis. Cut 3 mm from crystal seed surface.



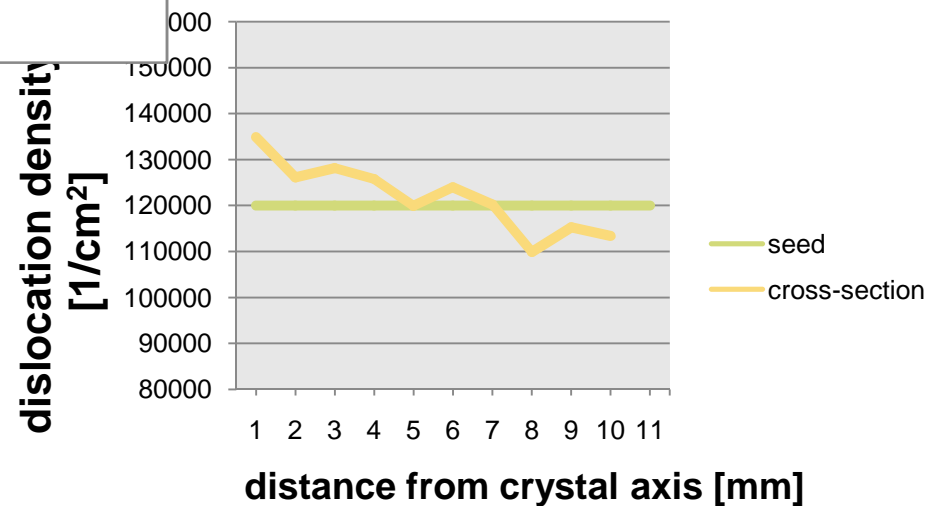


Dislocations

Dislocation densities in real process

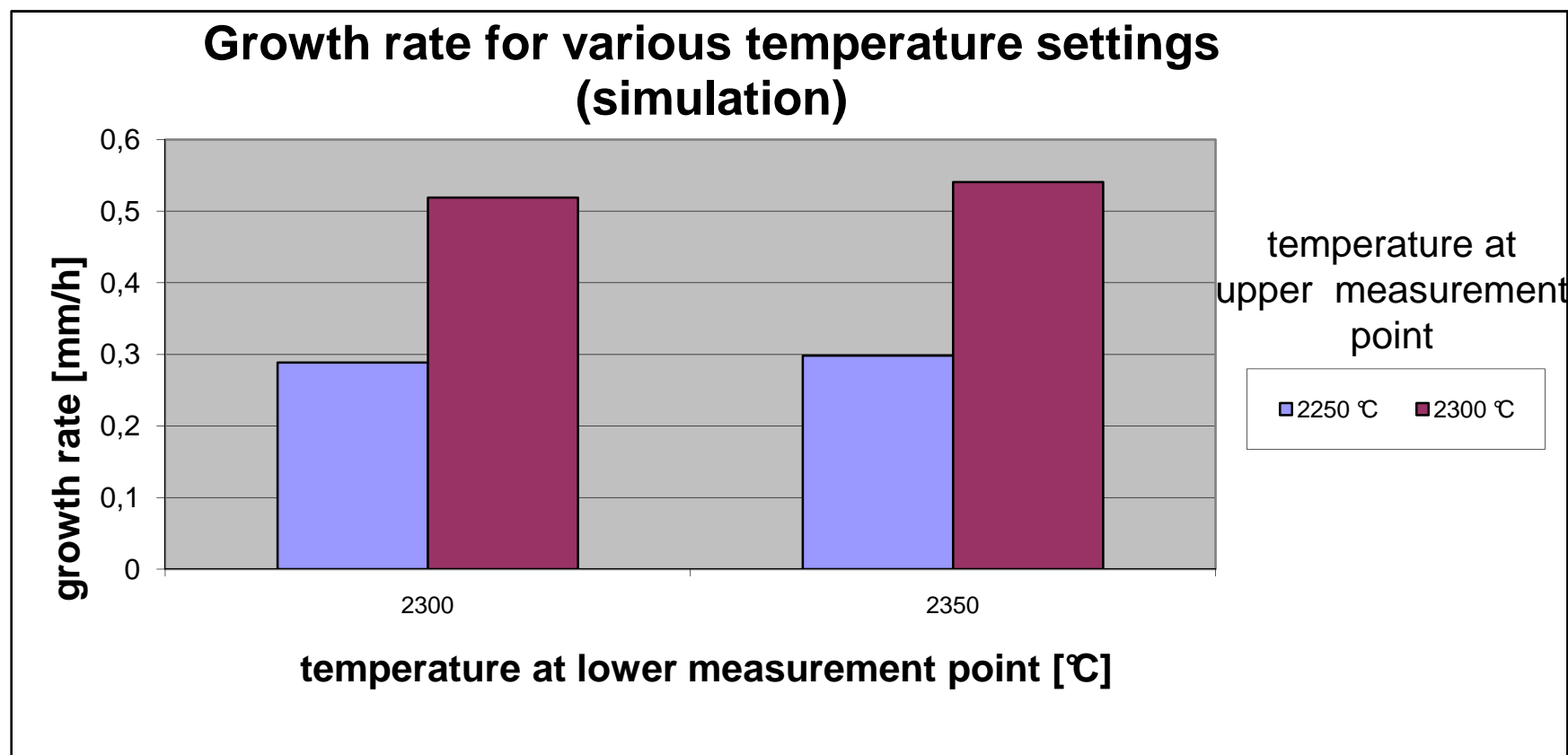


Dislocation density distribution from simulation



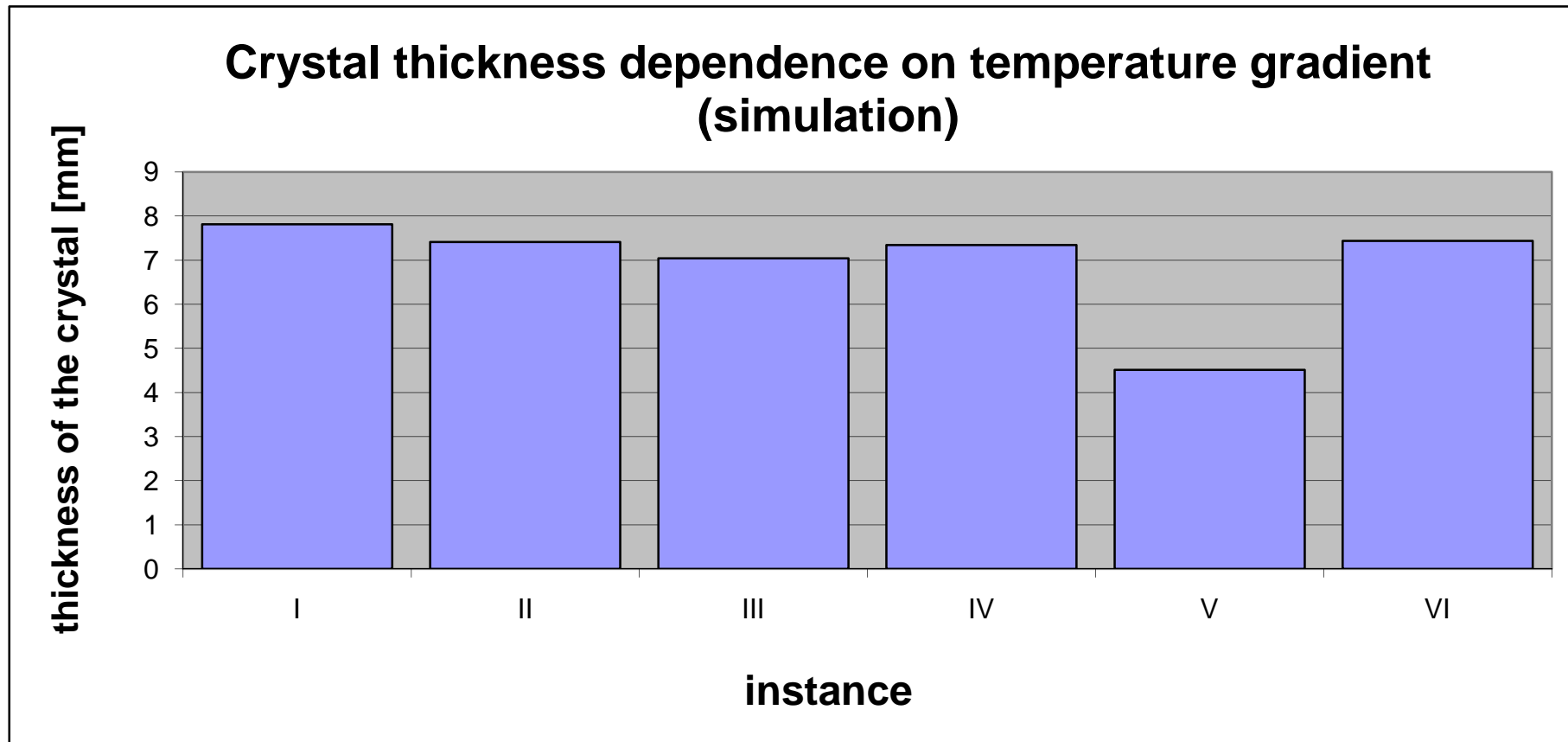


Effect of temperature on growth rate





Effect of temperature gradient on projected crystal thickness





Summary

- ▶ computer modelling is a viable tool for designing optimal conditions for SiC monocrystal growth
- ▶ modeling gives you opportunity to check the correctness of much more theories and ideas than the experiment alone
- ▶ saves time and resources